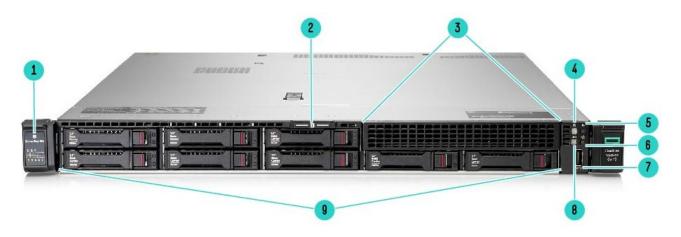
QuickSpecs

Overview

HPE Cloudline CL2600 Gen10 Server

Need an open system known for its design, reliability, and global support? The HPE Cloudline CL2600 Gen10 Server is the standard of open systems in a 1U Hewlett Packard Enterprise flagship design. From quality controls and rigor in the manufacturing and design, to security controls in the supply chain, this server represents peace of mind. It is ideal for service providers, hyperscalers, and a segment of traditional enterprise customers seeking commonality in the server options and management across vendors. Deploy globally and confidently with HPE's global service and support.

The HPE Cloudline CL2600 Gen10 Server supports Intel® Xeon® Scalable processors, six memory channels per CPU, an AMI BIOS for open systems management, and industry standard options, all in a 1U standard-depth chassis with options for power supplies to support AC and DC power. In addition, the server supports up to 8 SFF SAS/SATA HDD/SSD, making it an excellent choice for standardizing a broad set of workloads.



8 SFF- 8SFF Server shown with Optional 2SFF NVMe drives - Front View

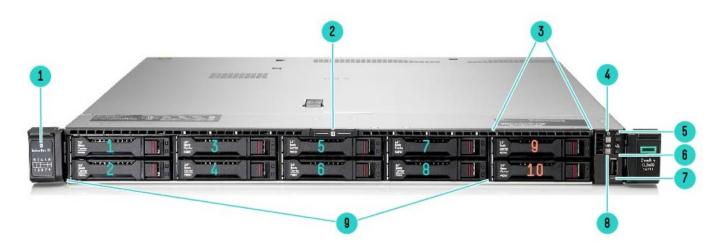
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|---|
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- 1. Drive Support Label
- 2. Serial number label pull tab
- 3. Optional: +2 SFF NVMe Option
- 4. Power On/Standby and system power LED
- 5. Health LED

Item Description

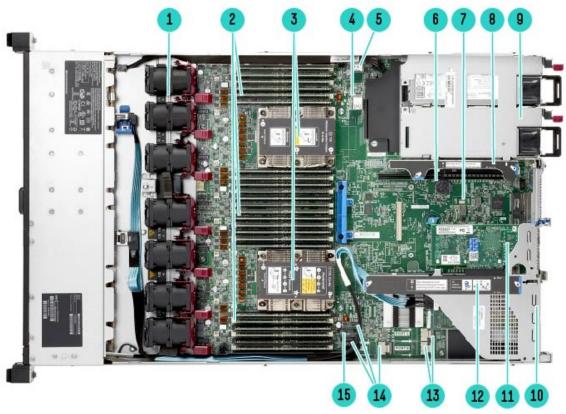
- 6. NIC Status LED
- 7. USB 3.0 port
- 8. UID LED
- 9. Up to 8 SFF SAS/SATA HDD/SSD drive bays





Premium 10SFF NVMe Front View

| ltem | Description | ltem | Description |
|------|---------------------------------------|------|--|
| 1. | Drive Support Label | 6. | NIC Status LED |
| 2. | Serial number label pull tab | 7. | USB 3.0 port |
| 3. | 2 SFF NVMe drive bays | 8. | UID LED |
| 4. | Power On/Standby and system power LED | 9. | 8 SFF SAS/SATA/NVME HDD/SSD drive bays |
| 5. | Health LED | | |



Standard for all CL2600 Gen10 - Internal View

- 1. Standard single rotor hot plug fans¹
- 2. DDR4 DIMM slots (Fully populated 24 DIMMs shown)
- 3. Up to 2 processors (shown with standard heat sinks)
- 4. Dual internal USB 3.0 connector (top arrow)
- 5. Hard Drive backplane power connector
- 6 System Battery
- 7 Optional: TPM 2.0
- 8 Secondary (CPU2) PCIe 3.0 riser ²

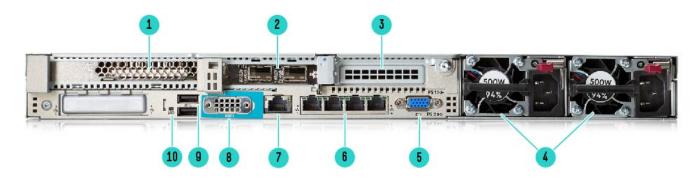
- 9. Up to 2 Power Supplies for redundant power. ³
- 10. Slot 1 from Primary Riser (bottom arrow)
- 11. Slot 2 from Primary Riser (top arrow; expansion card shown);
- 12. Primary (CPU1) PCle 3.0 riser 4
- 13. x4 SATA port 1&2
- 14. Reserved
- 15. Front Power USB 3.0 connector (bottom arrow)

NOTE 1: 1 CPU – 5 standard fans, 2 CPUs – 7 standard fans. 7 High-Performance Fans (P10544-B21) optional for 8SFF chassis, required upon selecting 2NVMe Backplane kit with 8SFF chassis, and standard for Premium 10SFF chassis

NOTE 2: Not available on Premium 10SFF chassis due to dedicated 10 x4 NVMe direct attach PCle riser; Optional 1x16 Low Profile Riser for 8SFF Chassis corresponding to Slot 3 in the rear; requires 2 processors for functionality

NOTE 3: Options for 500/800/1600W AC and 800W DC

NOTE 4: Standard: x16/x8. Optional: x16/x16 + Dual M.2 SATA on riser (P10572-B21). OR x16/x8 + Dual x4 NVMe (P09679-B21)



Standard for all CL2600 Gen10 - Rear View

- 1. Slot 1 from Primary PCle 3.0 riser (x16)
- 2. Slot 2 from Primary PCle 3.0 riser¹
- 3. Slot 3 from Secondary PCle 3.0 riser²
- 4. Power Supply (PS1&PS2)
- 5. VGA port

- 6. Embedded 4x 1GbE Adapter
- 7. BMC Management Port (1Gb)
- 8. Optional serial port (with serial cable)
- 9. 2x USB 3.0 Ports
- 10. Rear UID LED

NOTE 1: 1x8 standard or 1x16 with optional M.2 riser

NOTE 2: Not available on Premium 10SFF chassis due to dedicated 10 x4 NVMe direct attach PCIe riser; Optional 1x16 Low Profile Riser for 8SFF Chassis corresponding; requires 2 processors for functionality

What's New

- Open standards system in a general purpose 1U design, supporting open, industry-standard options
- Open systems management Redfish®, BMC®, IPMI 2.0
- Supports Intel Xeon Processor Scalable Family
- Supports up to 8 SFF SAS/SATA HDD/SSD, or up to 10SFF NVMe SSD
- Keep data secure via Intel® Boot Guard and UEFI Secure boot
- BIOS configuration via Redfish API

Platform Information Form Factor

1U rack

Chassis Types

8 SFF chassis supporting SAS/SATA HDD/SSD with optional 2 NVMe or dual (2x) M.2 2280 SATA cartridges 10 SFF Premium chassis supporting 2 NVME and up to 8 SFF SAS/SATA/NVME with optional dual (2x) M.2 2280 SATA cartridges

System Fans

Single rotor hot plug fans will be included

NOTE: The CL2600 Gen10 will support up to 7 fans with fan redundancy built in. One fan rotor failure will place server in degraded mode but fully functional. Two fan rotor failures could provide warning and imminent server shutdown.

For 8 SFF chassis:

1 CPU – Includes 5 standard fans 2 CPUs – Includes 7 standard fans

NOTE: Optional High-Performance Fan Kit (P10544-B21) available (includes 7 fans).

For 10 NVMe Premium chassis:

2 CPUs – Includes 7 high performance fans as standard

Standard Features

Processors – Up to 2 of the following depending on model.

NOTE: For more information regarding Intel Xeon processors, please see the following http://www.intel.com/xeon.

NOTE: This table covers the public Intel offering only.

| Gold 6152 Processor | 2.1 GHz | 22 | 30.25 MB | 140W | 3 @ 10.4 GT/s | 2666 MT/s | 768GB |
|---------------------|---------|----|----------|------|---------------|-----------|-------|
| Gold 6148 Processor | 2.4 GHz | 20 | 27.50 MB | 150W | 3 @ 10.4 GT/s | 2666 MT/s | 768GB |
| Gold 6144 Processor | 3.5 GHz | 8 | 24.75 MB | 150W | 3 @ 10.4 GT/s | 2666 MT/s | 768GB |
| Gold 6142 Processor | 2.6 GHz | 16 | 22.00 MB | 150W | 3 @ 10.4 GT/s | 2666 MT/s | 768GB |
| Gold 6140 Processor | 2.3 GHz | 18 | 24.75 MB | 140W | 3 @ 10.4 GT/s | 2666 MT/s | 768GB |
| Gold 6138 Processor | 2.0 GHz | 20 | 27.50 MB | 125W | 3 @ 10.4 GT/s | 2666 MT/s | 768GB |
| Gold 6136 Processor | 3.0 GHz | 12 | 24.75 MB | 150W | 3 @ 10.4 GT/s | 2666 MT/s | 768GB |
| Gold 6134 Processor | 3.2 GHz | 8 | 24.75 MB | 130W | 3 @ 10.4 GT/s | 2666 MT/s | 768GB |
| Gold 6130 Processor | 2.1 GHz | 16 | 22.00 MB | 125W | 3 @ 10.4 GT/s | 2666 MT/s | 768GB |
| Gold 6128 Processor | 3.4 GHz | 6 | 19.25 MB | 115W | 3 @ 10.4 GT/s | 2666 MT/s | 768GB |
| Gold 6126 Processor | 2.6 GHz | 12 | 19.25 MB | 125W | 3 @ 10.4 GT/s | 2666 MT/s | 768GB |
| Gold 5122 Processor | 3.6 GHz | 4 | 16.50 MB | 105W | 2 @ 10.4 GT/s | 2666 MT/s | 768GB |
| Gold 5120 Processor | 2.2 GHz | 14 | 19.25 MB | 105W | 2 @ 10.4 GT/s | 2400 MT/s | 768GB |
| Gold 5118 Processor | 2.3 GHz | 12 | 16.50 MB | 105W | 2 @ 10.4 GT/s | 2400 MT/s | 768GB |
| Gold 5115 Processor | 2.4 GHz | 10 | 13.75 MB | 85W | 2 @ 10.4 GT/s | 2400 MT/s | 768GB |

NOTE: Gold Processors:

- 2 and 4 socket capable, 2S 2UPI, 4S 3UPI @ 10.4 GT/s.
- 6-Channel DDR4 @ 2400 MT/s (SKU 5122 supports 2666 MT/s).
- 768 GB max memory capacity per socket
- Intel Turbo Boost Technology, Intel Hyper-Threading Technology, Intel AVX-512 (1x 512-bit FMA) (SKU 5122 supports 2x 512-bit FMA).
- 48 lanes PCle 3.0, advanced RAS.

| Silver 4116 Processor | 2.1 GHz | 12 | 16.50 MB | 85W | 2 @ 9.6 GT/s | 2400 MT/s | 768GB |
|-----------------------|---------|----|----------|-----|--------------|-----------|-------|
| Silver 4114 Processor | 2.2 GHz | 10 | 13.75 MB | 85W | 2 @ 9.6 GT/s | 2400 MT/s | 768GB |
| Silver 4112 Processor | 2.6 GHz | 4 | 8.25 MB | 85W | 2 @ 9.6 GT/s | 2400 MT/s | 768GB |
| Silver 4110 Processor | 2.1 GHz | 8 | 11.00 MB | 85W | 2 @ 9.6 GT/s | 2400 MT/s | 768GB |
| Silver 4108 Processor | 1.8 GHz | 8 | 11.00 MB | 85W | 2 @ 9.6 GT/s | 2400 MT/s | 768GB |

NOTE: Silver Processors:

- 2 socket capable, 2S 2UPI @ 9.6 GT/s.
- 6-Channel DDR4 @ 2400 MT/s, 768 GB max memory capacity.
- Intel Turbo Boost Technology, Intel Hyper-Threading Technology, Intel AVX-512 (1x 512-bit FMA).
- 48 lanes PCle 3.0, standard RAS.

| Bronze 3106 Processor | 1.7 GHz | 8 | 11.00 MB | 85W | 2 @ 9.6 GT/s | 2133 MT/s | 768GB |
|------------------------------|---------|---|----------|-----|--------------|-----------|-------|
| Bronze 3104 Processor | 1.7 GHz | 6 | 8.25 MB | 85W | 2 @ 9.6 GT/s | 2133 MT/s | 768GB |

NOTE: Bronze Processors:

- 2 socket capable, 2S 2UPI @ 9.6 GT/s.
- 6-Channel DDR4 @ 2133 MT/s, 768 GB max memory capacity.
- Intel AVX-512 (1x 512-bit FMA).
- 48 lanes PCIe 3.0, standard RAS.

Chipset

Intel C621 Chipset

NOTE: For more information regarding Intel® chipsets, please see the following

URL: http://www.intel.com/products/server/chipsets/.

On System Management Chipset

HPE BMC – remote server management processor embedded on the system board of the server

Memory

Type DDR4 Industry Standard DDR4 Registered (RDIMM), Load Reduced (LRDIMM)

Memory

DIMM Slots Available 24 12 DIMM slots per processor, 6 channels per processor,

2 DIMMs per channel

Maximum capacity (LRDIMM) 1.5 TB 24 x 64 GB LRDIMM @ 2666 MT/s
Maximum capacity (RDIMM) 768 GB 24 x 32 GB RDIMM @ 2666 MT/s

NOTE: Maximum memory per socket is dependent on processor selection. Processors supporting 1.5 TB per CPU is indicated by

the "M" in the processor model names (i.e. 6134M).

NOTE: Mixing of RDIMM and LRDIMM memory is not supported.

NOTE: For General Server Memory Population Rules and Guidelines for Gen10 see details here:

http://www.hpe.com/docs/memory-population-rules

Memory Protection

Advanced ECC Advanced ECC uses single device data correction to detect and correct single and all multibit error

that occurs within a single DRAM chip.

Online Spare Memory online spare mode detects a rank that is degrading and switches operation to the spare

rank.

| Expansion Slots | | | | | | |
|---------------------------|----------------------|------------|--------------|--------------------|-----------|---------------------------------------|
| Primary Riser | Expansion Slots # | Technology | Bus Width | Connector Width | Processor | Slot Form Factor |
| | 1 | PCle 3.0 | x16 | x16 | CPU1 | Full-height, 3/4 length (up to 9.5in) |
| | 2 | PCle 3.0 | x8 | x8 | CPU1 | Low Profile |
| Primary SATA M.2 Riser | Expansion Slots # | Technology | Bus Width | Connector Width | Processor | Slot Form Factor |
| | 1 | PCIe 3.0 | x16 | x16 | CPU 1 | Full-height; 3/4 length (up to 9.5in) |
| | 2 | PCle 3.0 | x16 | x16 | CPU 1 | Low Profile |
| Primary NVMe Riser | Expansion Slots # | Technology | Bus Width | Connector Width | Processor | Slot Form Factor |
| | 1 | PCIe 3.0 | x16 | x16 | CPU 1 | Full-height; 3/4 length (up to 9.5") |
| | 2 | PCIe 3.0 | x8 | x8 | CPU 1 | Low Profile |
| Secondary Riser* | Expansion Slots # | Technology | Bus Width | Connector Width | Processor | Slot Form Factor |
| | 3 | PCle 3.0 | x16 | x16 | CPU 2 | Low Profile |

Storage Controllers Software RAID

Intel C621 AHCI SATA RAID with 8 SATA ports (embedded)

RAID Controllers

Broadcom 9460-8i RAID Controller LSI 9361-8i RAID Controller

HBA Controllers

LSI 9300-8i SAS HBA Card

Internal Storage Devices

Hard Drives None ship standard

Maximum Storage

| Hot Plug SFF SATA SSD 61.44 TB 8 x 7.68 TB | Storage | Capacity | Configuration |
|---|----------------------------|----------|----------------|
| 5 | Hot Plug SFF SAS HDD | 19.2 TB | 8 x 2.4 TB |
| Hot Plug SFF NVMe PCle SSD 80 TB 10 x 8 TB NVMe | Hot Plug SFF SATA SSD | 61.44 TB | 8 x 7.68 TB |
| | Hot Plug SFF NVMe PCle SSD | 80 TB | 10 x 8 TB NVMe |

Power Supply

HPE 500W Flex Slot Platinum Hot Plug Low Halogen Power Supply Kit

NOTE: Available in 94% efficiency.

HPE 800W Flex Slot Platinum Hot Plug Low Halogen Power Supply Kit

NOTE: Available in 94% and 96% efficiency.

NOTE: Also available in -48VDC and 227VAC/380VDC power inputs.

HPE 1600W Flex Slot Platinum Hot Plug Low Halogen Power Supply Kit

NOTE: Available in 94% efficiency.

NOTE:1600W Power supplies only support high line voltage (200 VAC to 240 VAC).

HPE Flexible Slot (Flex Slot) Power Supplies share a common electrical and physical design that allows for hot plug, tool-less installation into HPE Gen10 Performance Servers. Flex Slot power supplies are certified for high-efficiency operation and offer multiple power output options, allowing users to "right-size" a power supply for specific server configurations. This flexibility helps to reduce power waste, lower overall energy costs, and avoid "trapped" power capacity in the data center.

The CL2600 Gen10 ships with a standard 6-foot IEC C-13/C-14 jumper cord (A0K02A) to support AC power supplies selected. If a different power cord is required, please check the **HPE Power Cables** web page.

To review the power requirements for your selected system, please use the HPE Power Advisor Tool.

For information on power specifications and technical content visit **HPE Server Power Supplies**.

Interfaces

Serial 1 Port with cable - Optional

Video 1 Rear - VGA port (standard on all chassis types)

Network Ports 4x 1GbE embedded NIC (standard on all chassis types)

BMC Remote Mgmt Port 1 Gb Dedicated

USB 3.0 Up to 5: 1 front, 2 rear, 2 internal (standard on all chassis types)

Operating Systems and Virtualization Software

- Operating Systems and Virtualization Software Support for ProLiant Servers
- Microsoft Windows Server 2012 R2
- Microsoft Windows Server 2016
- Red Hat Enterprise Linux 6.9, 6.10
- Red Hat Enterprise Linux 7.4, 7.5
- SLES 12 SP3
- VMware vSphere 6.5 U1

NOTE: For more information visit http://www.hpe.com/info/ossupport

Industry Standard Compliance

- AMI Aptio 5.12
- UEFI 2.5 Support
- UEFI Shell 2.1 Support
- UEFI PI 1.4 Support
- ACPI 6.1 Compliant
- PCIe 3.0 Compliant
- SMBIOS 3.0
- PXE Support
- WOL Support
- USB 3.0 Compliant
- USB 2.0 Compliant
- Redfish version 1.0
- IPMI 2.0
- DCMI (Data Center Management Interface), version 1.5
- SPS 3.0
- SMBUS 2.0

Graphics

Integrated video standard

Video modes up to 1920 x 1200 @ 60 Hz (32 bpp)

AMI UEFI BIOS

Unified Extensible Firmware Interface (UEFI) is an industry standard for better manageability and secured configuration than the legacy ROM at boot time. HPE Cloudline Gen10 servers have a UEFI Class 2 implementation and support both UEFI Mode (default) and Legacy BIOS Mode. Please reference the CL2600 User & Maintenance Guide.

- UEFI enables numerous new capabilities specific to HPE servers such as:
- Secure Boot and Secure Start enable for enhanced security
- Operating system specific functionality
- Support for > 2.2 TB (using GPT) boot drives
- USB 3.0 Stack
- Embedded UFFI Shell
- PXE boot support for IPv6 networks
- UEFI Boot Mode only
- TPM 2.0 Support
- NVMe Boot Support
- iSCSI Software Initiator Support.
- HTTP Boot support
- Boot support for option cards that only support a UEFI option ROM

NOTE:For UEFI Boot Mode, boot environment and OS image installations should be configured properly to support UEFI. **NOTE:**Legacy FIO Setting (P11219-B22) can be selected to configure the system in Legacy mode in the factory for your HPE Cloudine Gen10 Server.

Embedded Management

Open Systems BMC

Industry standard baseboard management controller (BMC®) for effective remote management with IPMI / Redfish®, and DCMI/PXE boot standard interfaces allowing simple/scripted integration into an application infrastructure. A user can access the BMC firmware (FW), via a web browser, or scripting for server status configurations, user(s) privilege setup, FW updates, power control, event logging, BMC Network, serial port management, and SOL configuration.

Redfish API

Redfish API conformance and offers simplified server management automation such as configuration and maintenance tasks based on modern industry standards.

Security

- UEFI Secure Boot and Secure Start Support
- SECURE FLASH
- SSL (HTTPS) for secured sessions
- TPM (Trusted Platform Module) 2.0 option

NOTE: TPM 2.0 only works when UEFI is set to default

Bezel Locking Kit

Warranty

Hardware support is available for 3 years from date of purchase. Support for software and initial setup is available for 90 days from date of purchase. Hard drives have either a one year or three-year warranty; refer to the HPE Cloudline Servers and Options Global Limited Warranty and Technical Support for details.

NOTE: Server Warranty includes 3 Years Parts with five (5) days response time, 0 Years Labor, and 0 Years Onsite Support. Additional information regarding worldwide limited warranty and technical support is available at

http://www.hpe.com/support/cloudline_warranty_en.

Response time

Response times are based on local standard business days and working hours. Unless otherwise stated, all responses are measured from the time the customer calls until Hewlett Packard Enterprise has either established a mutually acceptable time for support to be performed, or Hewlett Packard Enterprise has begun to provide support or remote diagnostics. Response time is based on commercially reasonable effort. In some countries and under certain supplier constraints, response time may vary. If your location is outside the customary service zone, response time may be longer or there may be an additional charge. Contact your local Hewlett Packard Enterprise service organization for response time availability in your area.

Optional Features

Rack and Power Infrastructure

The story may end with servers, but it starts with the foundation that makes compute go – and business grow. We have reinvented our entire portfolio of rack and power products to make IT infrastructure more secure, more practical, and more efficient. In other words, we've created a stronger, smarter, and simpler infrastructure to help you get the most out of your IT equipment. As an industry leader, Hewlett Packard Enterprise is uniquely positioned to address the key concerns of power, cooling, cable management and system access.

HPE G2 Advanced and Enterprise Racks are perfect for the server room or today's modern data center with enhanced airflow and thermal management, flexible cable management, and a 10 year Warranty to support higher density computing.

HPE G2 PDUs offer reliable power in flexible form factors that operate at temperatures up to 60°, include color-coded outlets and load segments and a low-profile design for optimal access to the rack and support for dense rack environments.

HPE Uninterruptible Power Systems are cost-effective power protection for any type workload. Some UPSs include options for remote management and extended runtime modules so you're critical dense data center is covered in power outages.

HPE KVM Solutions include a console and switches designed to work with your server and IT equipment reliably. We have got a cost-effective KVM switch for your first rack and multiple connection IP switches with remote management and security capabilities to keep your data center rack up and running.

Learn more about HPE Racks, KVM, PDUs and UPSs at HPE Rack and Power Infrastructure.

Service and Support

Protect your business beyond warranty with Foundation Care NBD and Cloudline Support Services

HPE Foundation Care Next Business Day and Cloudline Support Services provide remote diagnosis and support, scheduled onsite hardware repair/troubleshooting, and coverage for replacement components. Also available with defective media retention (DMR) or comprehensive defective media retention (CDMR) services.

Extended support duration for up to 5 years is available on Foundation Care NBD services.

- HPE Cloudline 3 Years Parts + Remote Technical Support + Defective Media Retention
- HPE Cloudline 3 Years Parts + Remote Technical Support + Comprehensive Defective Media Retention
- HPE Foundation Care Next Business Day (3, 4, and 5 years options)
- HPE Foundation Care Next Business Day + Defective Media Retention (3, 4, and 5 years options)
- HPE Foundation Care Next Business Day + Comprehensive Defective Media Retention (3, 4, and 5 years options)

More information on Foundation Care NBD available at: https://h20195.www2.hpe.com/v2/getpdf.aspx/4aa4-8876enw.pdf.

More information on Cloudline Support Services available at:

https://h20195.www2.hpe.com/v2/GetPDF.aspx/4AA5-9207ENN.pdf

Standard Support Recommendation

Connect to Hewlett Packard Enterprise for faster problem resolution. Cloudline Carepack Services provides hardware onsite response. Simplify your support experience and make Hewlett Packard Enterprise your first call for hardware or software questions.

Parts and Materials

Hewlett Packard Enterprise will provide HPE-supported replacement parts and materials necessary to maintain the covered hardware product in operating condition, including parts and materials for available and recommended engineering improvements.

Parts and components that have reached their maximum supported lifetime and/or the maximum usage limitations as set forth in the manufacturer's operating manual, product quick-specs, or the technical product data sheet will not be provided, repaired, or replaced as part of these services.

The defective media retention service feature option applies only to Disk or eligible SSD/Flash Drives replaced by Hewlett Packard Enterprise due to malfunction.

Datacenter Care for Hyperscale

DC for Hyperscale is available for Service Providers and HPC customers who use a scale out approach to computing with a high volume homogenous infrastructure and resilient architecture. Customers can take advantage of this environment support tailored to their operating model. More information at https://h20195.www2.hpe.com/v2/GetPDF.aspx/4AA6-3460ENW.pdf.

Spares Management Service

Provides customers with spare parts inventory for onsite stocking, and access to the HPE Spares Management Tool – an automated inventory management tool that helps enable real-time inventory management. More information at

https://h20195.www2.hpe.com/v2/GetPDF.aspx/4AA1-3116ENW.pdf.

Advisory & Professional Services

Design, strategy, road map, and other services to help enable the digital transformation journey, tuned to IT and business needs. Advisory Services helps customers on their journey to Hybrid IT, Big Data, and the Intelligent Edge. More information at

https://www.hpe.com/us/en/services/consulting.html.

Operational offerings to improve performance and securely handle retirement of customers' IT environments.

Operate & Improve performance, minimize risk of downtime, and reduce security risks.

Retire & Sanitize to safely and securely dispose of retired IT, and ensuring customer data cannot be compromised.

Integrate the new solution with project management, installation and startup, relocation services, and more. We help mitigate risk to the business so there is no interruption when new technology is being integrated in the existing IT environment. More information at https://www.hpe.com/us/en/services/professional.html.

Configuration Information

This section lists some of the steps required to configure a Factory Integrated Model.

To ensure valid configurations are ordered, Hewlett Packard Enterprise recommends the use of an HPE approved configurator. Contact your local sales representative for information on configurable product offerings and requirements.

- 1. Factory Integrated Models must start with a CTO Server.
- 2. FIO indicates that this option is only available as a factory installable option.
- 3. All Factory Integrated Models (FIO) will include the hard drive carriers
- 4. Some options may not be integrated at the factory. Contact your local sales representative for additional information

Step 1: Base Configuration (choose one of the following configurable models)

| orep in Buse coming a | manion (choose one of the following configurable in | ouc.is, | | | | |
|--------------------------|---|--|--|--|--|--|
| CTO Server | 8SFF | Premium 10SFF | | | | |
| SKU Number | P04359-B21 | P09678-B21 | | | | |
| Processor | Not included | d as standard | | | | |
| DIMM Slots | 24-DIMM slot | s (12 per CPU) | | | | |
| Storage Controller | Choice of Intel C621 embedded SW RAID with 8 SATA ports or optional PCIe plug-in RAID/HBA controlle | | | | | |
| PCIe | 2 PCle slots (1 x16 FH / 1 x8 LP) Optional: 1 x16 FH or LP | 2 PCle slots (1 x16 FH / 1 x8 LP) | | | | |
| Drive Cage - included | 8 SFF - SAS/SATA Optional: up to 2 NVMe or 1 Dual (2x) 2280 M.2 cartridges | 10 NVMe – 8 SAS/SATA/NVME + 2 NVME Optional: 1 Dual (2x) 2280 M.2 cartridges | | | | |
| Network Controller | 1Gb Ethernet 4-Port plus optional PCIe stand up card(s) | | | | | |
| Fans | 1 CPU – 5 Standard Fans 2 CPU – 7 Standard Fans Optional: High Performance Fans | 2 CPU – 7 High Performance Fans | | | | |
| Management | HPE BMC & AMI Firmware | | | | | |
| USB | Front: 1 USB 3.0 Rear: 2 USB 3.0 Internal: 2 USB 3.0 | | | | | |

Step 2a: Choose Processor Options

Please select a minimum of one or maximum of two -L21 processors below. The Premium 10SFF base server requires two -L21 processors be selected.

NOTE: For first processor selection on the 8SFF chassis, it will include 5 fans; For second processor selection (if applicable), it will add 2 additional fans. For the 8SFF chassis, the high performance fan kit (P10544-B21) is an optional upgrade, but required when selecting the 2NVMe backplane FIO kit (P09679-B21). For the Premium 10SFF chassis, 7 high performance fans come standard.

NOTE: Maximum memory capacity per processor is dependent on processor models. All processors support up to 768 GB max memory per processor except "M" model processors, which will support up to 1.5 TB max memory per processor.

NOTE: Mixing of 2 different processor models is NOT allowed.

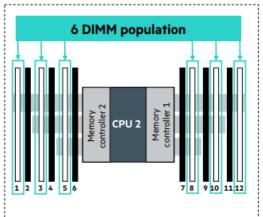
NOTE: DDR4 speed is the maximum memory speed of the processor. Actual memory speed may depend on the quantity and type of DIMMs installed.

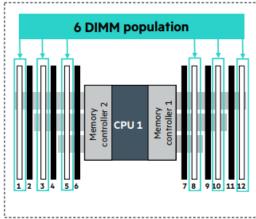
NOTE: Processors with 130W or higher will ship with a high-performance heatsink plus SKUs 6128, 5122 as noted below. All other will processors will ship with the Standard heat sink.

Configuration Information

| Processor Option Kits | Required Processor |
|--|-----------------------|
| Intel Xeon-Gold | |
| HPE CL Intel Xeon-Gold 6152 (2.1GHz/22-core/140W) FIO Processor Kit | P01905-L21 |
| NOTE: Ships with High Performance Heatsink. | |
| HPE CL Intel Xeon-Gold 6148 (2.4GHz/20-core/150W) FIO Processor Kit | P01747-L21 |
| NOTE: Ships with High Performance Heatsink. | |
| HPE CL Intel Xeon-Gold 6144 (3.5GHz/8-core/150W) FIO Processor Kit | P01743-L21 |
| NOTE: Ships with High Performance Heatsink. | |
| HPE CL Intel Xeon-Gold 6142 (2.6GHz/16-core/150W) FIO Processor Kit | P01746-L21 |
| NOTE: Ships with High Performance Heatsink. | |
| HPE CL Intel Xeon-Gold 6140 (2.3GHz/18-core/140W) FIO Processor Kit | P01904-L21 |
| NOTE: Ships with High Performance Heatsink. | |
| HPE CL Intel Xeon-Gold 6138 (2.0GHz/20-core/125W) FIO Processor Kit | P01903-L21 |
| HPE CL Intel Xeon-Gold 6136 (3.0GHz/12-core/150W) FIO Processor Kit | P01745-L21 |
| NOTE: Ships with High Performance Heatsink. | |
| HPE CL Intel Xeon-Gold 6134 (3.2GHz/8-core/130W) FIO Processor Kit | P01906-L21 |
| NOTE: Ships with High Performance Heatsink. | |
| HPE CL Intel Xeon-Gold 6130 (2.1GHz/16-core/125W) FIO Processor Kit | P01902-L21 |
| HPE CL Intel Xeon-Gold 6128 (3.4GHz/6-core/115W) FIO Processor Kit | P01742-L21 |
| NOTE: Ships with High Performance Heatsink | |
| HPE CL Intel Xeon-Gold 6126 (2.6GHz/12-core/125W) FIO Processor Kit | P01744-L21 |
| HPE CL Intel Xeon-Gold 5122 (3.6GHz/4-core/105W) FIO Processor Kit | P01741-L21 |
| NOTE: Ships with High Performance Heatsink | |
| HPE CL Intel Xeon-Gold 5120 (2.2GHz/14-core/105W) FIO Processor Kit | P01901-L21 |
| HPE CL Intel Xeon-Gold 5118 (2.3GHz/12-core/105W) FIO Processor Kit | P01900-L21 |
| HPE CL Intel Xeon-Gold 5115 (2.4GHz/10-core/105W) FIO Processor Kit | P01795-L21 |
| Intel Xeon-Silver | |
| HPE CL Intel Xeon-Silver 4114 (2.2GHz/10-core/85W) FIO Processor Kit | P01898-L21 |
| HPE CL Intel Xeon-Silver 4112 (2.6GHz/4-core/85W) FIO Processor Kit | P01794-L21 |
| HPE CL Intel Xeon-Silver 4110 (2.1GHz/8-core/85W) FIO Processor Kit | P01897-L21 |
| HPE CL Intel Xeon-Silver 4108 (1.8GHz/8-core/85W) FIO Processor Kit | P01896-L21 |
| HPE CL Intel Xeon-Silver 4116 (2.1GHz/12-core/85W) FIO Processor Kit | P01899-L21 |
| Intel Xeon-Bronze | |
| HPE CL Intel Xeon-Bronze 3106 (1.7GHz/8-core/85W) FIO Processor Kit | P01895-L21 |
| HPE CL Intel Xeon-Bronze 3104 (1.7GHz/6-core/85W) FIO Processor Kit | P01894-L21 |
| Step 2b: Choose Memory Options | |
| Please select one or more memory from below. | |
| For new Gen10 memory population rule whitepaper and optimal memory performance guidelines, please go to: https://www.hpe.com/docs/memory-population-rules | |

Configuration Information





Balanced across two CPUs - 12 DIMMs

NOTE: Maximum memory capacity per processor is dependent on processor model selection or limitation. **NOTE:** Maximum memory speed is dependent on processor model selection or limitation.

| Registered | DIMMs (| (RDIMMs) |
|------------|---------|----------|
|------------|---------|----------|

| Lord District District (LDDISMA) | |
|--|------------|
| HPE CL 16GB (1x16GB) Single Rank x8 DDR4-2666 CAS-19-19 Registered Memory FIO Kit | 881067-B21 |
| HPE CL 16GB (1x16GB) Dual Rank x8 DDR4-2666 CAS-19-19-19 Registered Memory FIO Kit | P07029-B21 |
| HPE CL 32GB (1x32GB) Dual Rank x4 DDR4-2666 CAS-19-19-19 Registered Memory FIO Kit | 880841-B21 |

Load Reduced DIMMs (LRDIMMs)

HPE CL 64GB (1x64GB) Quad Rank x4 DDR4-2666 CAS-19-19-19 Load Reduced Memory FIO Kit 880842-B21

Step 2c: Choose Power Supplies

Please select one or two power supplies from below.

NOTE: Mixing of 2 different power supplies is NOT allowed.

HPE Flex Slot Power Supplies

| HPE 500W Flex Slot Platinum Hot Plug Low Halogen Power Supply Kit | 865408-B21 |
|--|------------|
| HPE 800W Flex Slot Titanium Hot Plug Low Halogen Power Supply Kit | 865438-B21 |
| HPE 800W Flex Slot Platinum Hot Plug Low Halogen Power Supply Kit | 865414-B21 |
| HPE 800W Flex Slot -48VDC Hot Plug Low Halogen Power Supply Kit | 865434-B21 |
| HPE 1600W Flex Slot Platinum Hot Plug Low Halogen Power Supply Kit | 830272-B21 |
| NOTE 4/00W P | |

NOTE: 1600W Power supplies only support high line voltage (200 VAC to 240 VAC).

HPE 800W Flex Slot Universal Hot Plug Low Halogen Power Supply Kit

865428-B21

Step 3: Choose Additional (FIO) Factory Integrated Options

Each of the following may be selected if desired at time of factory integration

HPE Trusted Platform Module 2.0 Gen10 Option

864279-B21

NOTE: HPE Trusted Platform Module 2.0 option works with Gen10 servers with UEFI Mode, not Legacy Mode. **NOTE:** HPE server systems can have a TPM module installed only once. It cannot be replaced with any other TPM module.

Step 4: Choose Additional Options for Factory Integration from Core and Additional Option sections below

Core Options

HPE Unique Options

Risers

HPE CL 2600 Gen10 Low Profile FIO Riser Kit

P05476-B21

P10572-B21

| IPE CL2600 Gen10 SATA M.2 FIO Kit P10572-E | | | | | | P105/2-B21 | | | | |
|--|--|----------------|-----------|-----------------------------|-----|------------|---------------------|----------|------------------|--|
| iser Information* | | | | | | | | | | |
| Part number | Description | Riser position | | Slot Bus width (Gen3 lanes) | | | NVMe Direct Connect | | SATA m.2 2280 | |
| | | Primary | Secondary | #1 | #2 | #3 | Connectors | Max SSDs | Max drives | |
| n/a | HPE CL2600 Gen10 x16/x8 Primary Riser | D | N | x16 | x8 | 0 | | | | |
| P10572-B21 | HPE CL2600 Gen10 x16/x16 SATA M.2 2280 Riser Kit | 0 | N | x16 | x16 | 0 | | | 2 | |
| P05476-B21 | HPE CL2600 Gen10 x16 Low-Profile Riser Kit | N | 0 | 0 | 0 | x16 | | | | |
| n/a | HPE CL2600 Gen10 x16/x8 1-port 2SFF NVMe Riser ¹ | 0 | N | x16 | x8 | 0 | 1 | 2 | | |
| n/a | HPE CL2600 Gen10 5-port 10SFF NVMe Riser Kit ² | N | D^2 | 0 | 0 | 0 | 5 | 10 | | |

NOTE: D = Default on chassis; O = Optional; N = not supported or slot/connector not present

Performance Cooling Options

HPE CL2600 Gen10 High Performance FIO Fan Kit P10544-B21

Universal Media Bay Options

HPE CL2600 Gen10 2NVMe FIO Backplane Kit P09679-B21

NOTE: Only supported on 8SFF chassis P04359-B21

Security

HPE Trusted Platform Module 2.0 Gen10 Option 864279-B21
HPE 1U Gen10 Bezel Kit 867998-B21
HPE Bezel Lock Kit 875519-B21

NOTE: HPE Bezel Lock Kit (875519-B21) requires selecting HPE 1U Gen10 Bezel Kit (867998-B21)

Cable Kits

HPE CL2600/2800 Gen10 Rear Serial Cbl FIO P07013-B21

¹Included on 2SFF NVMe FIO Backplane Kit P09679-B21; only supported on 8SFF chassis P04359-B21

²Standard on Premium 10SFF chassis P09678-B21

Core Options

Hard Disk Drive (HDD) Selection Enterprise - 12G SAS - SFF - Hard Disk Drives HPE CL 300GB 12G SAS 15K rpm SFF (2.5in) Seagate Hard Drive P01660-B21 HPE CL 600GB 12G SAS 10K rpm SFF (2.5in) Enterprise Hard Drive 848513-B21 HPE CL 1.2TB 12G SAS 10K rpm SFF (2.5in) Enterprise Hard Drive 848505-B21 HPE CL 2.4TB 12G SAS 10K rpm SFF (2.5in) Seagate Enterprise Hard Drive 880853-B21 Solid State Drive (SSD) Selection Mixed Use - 6G SATA - SFF - Solid State Drives HPE CL 240GB SATA 6G Mixed Use SFF (2.5in) Micron 5200 FIO SSD P08787-B21 HPE CL 960GB 6G SATA Mixed Use SFF (2.5in) Micron 5100 3yr Wty Solid State Drive Kit P01686-B21 HPE CL 960GB SATA 6G Mixed Use SFF (2.5in) Intel S4610 FIO SSD P08811-B21 HPE CL 1.92TB SATA 6G Mixed Use SFF (2.5in) Intel S4610 FIO SSD P08814-B21 HPE CL 3.84TB SATA 6G Mixed Use SFF (2.5in) Intel S4610 FIO SSD P04597-B21 Read Intensive - 6G SATA - SFF - Solid State Drives HPE CL 240GB SATA 6G Read Intensive SFF (2.5in) Intel S4510 FIO SSD P08796-B21 HPE CL 480GB SATA 6G Read Intensive SFF (2.5in) Intel S4510 FIO SSD P08799-B21 HPE CL 960GB SATA 6G Read Intensive SFF (2.5in) Intel S4510 FIO SSD P08802-B21 HPE CL 1.92TB SATA 6G Read Intensive SFF (2.5in) Intel S4510 FIO SSD P08805-B21 HPE CL 1.92TB SATA 6G Read Intensive SFF (2.5in) Samsung PM883 FIO SSD P01680-B21 HPE CL 3.84TB 6G SATA Read Intensive SFF (2.5in) x 15mm Micron 5100 3yr Wty Solid State Drive Kit P01681-B21 HPE CL 3.84TB SATA 6G Read Intensive SFF (2.5in) Samsung PM883 FIO SSD 879720-B21 HPE CL 3.84TB SATA 6G Read Intensive SFF (2.5in) Intel S4510 FIO SSD P08808-B21 HPE CL 7.68TB SATA 6G Read Intensive SFF (2.5in) Samsung PM883 FIO SSD P01684-B21 Read Intensive - PCIe/NVMe - SFF - Solid State Drives HPE CL 960GB NVMe x4 Lanes Read Intensive SFF (2.5in) Samsung PM983 FIO SSD P10536-B21 HPE CL 1.92TB NVMe x4 Lanes Read Intensive SFF (2.5in) Samsung PM983 FIO SSD P06710-B21 HPE CL 2TB NVMe x4 Lanes Read Intensive SFF (2.5in) Intel P4510 FIO SSD P04600-B21 HPE CL 2TB NVMe Read Intensive SFF (2.5in) x 7mm Intel P4511 Solid State Drive FIO Kit P04602-B21 HPE CL 3.2TB NVMe x4 Lanes Mixed Use SFF (2.5in) Intel P4610 FIO SSD P06660-B21 HPE CL 3.84TB NVMe x4 Lanes Read Intensive SFF (2.5in) Samsung PM983 FIO SSD P06713-B21 HPE CL 4TB NVMe x4 Lanes Read Intensive SFF (2.5in) Intel P4510 FIO SSD P06663-B21 HPE CL 8TB NVMe x4 Lanes Read Intensive SFF (2.5in) Intel P4510 FIO SSD P04599-B21 Mixed Use - PCIe/NVMe - SFF - Solid State Drives HPE CL 3.2TB NVMe x4 Lanes Mixed Use SFF (2.5in) Intel P4610 FIO SSD P06660-B21 HPE CL 3.2TB NVMe x4 Lanes Mixed Use SFF (2.5in) Samsung PM1725b FIO SSD P06726-B21 Mixed Use - PCIe/NVMe - Add-in-card - Solid State Drives HPE CL 1.6TB NVMe x4 Lanes Mixed Use HHHL Samsung PM1725b FIO SSD P01676-B21

Core Options

| Mixed Use - 6G SATA - M.2 - Solid State Drives | |
|---|------------|
| HPE CL 240GB SATA 6G Mixed Use M.2 - UFF to SFF Micron 5100 FIO SSD | P08784-B21 |
| HPE Networking | |
| 100 Gigabit Ethernet adapters | |
| HPE CL Ethernet 100Gb 1-port QSFP28 Mellanox ConnectX-5 EN PCle3 FIO Card | 880150-B21 |
| NOTE Mellanox ethernet adapters require Legacy BIOS Mode Setting (P11219-B22) | |
| 50 Gigabit Ethernet adapters | |
| HPE CL Ethernet 50Gb 2-port SFP28 Mellanox ConnectX-5 Single Host PCle 3.0 Card | P01671-B21 |
| NOTE: Mellanox ethernet adapters require Legacy BIOS Mode Setting (P11219-B22) | |
| 25 Gigabit Ethernet adapters | |
| HPE CL Ethernet 25Gb 1-port SFP28 Intel XXV710 PCle 3.0 Card | P01667-B21 |
| HPE CL Ethernet 25Gb 2-port SFP28 Q41212 PCle 3.0 Card | P01669-B21 |
| HPE CL Ethernet 25Gb 2-port SFP+ Mellanox ConnectX-4 PCIe 3.0 Card | P01670-B21 |
| NOTE: Mellanox ethernet adapters require Legacy BIOS Mode Setting (P11219-B22) | |
| 10 Gigabit Ethernet adapters | |
| HPE CL Ethernet 10Gb 4-port Intel X710-T4 PCle3 FIO Adapter | P10662-B21 |
| HPE CL Ethernet 10Gb 4-port Intel X710D PCle3 FIO Adapter | P10664-B21 |
| HPE CL Ethernet 10GBASE-T 2-port Q41112 PCIe FIO Adapter | P08550-B21 |
| HPE CL Ethernet 10GBASE-T 2-port Intel X550 PCIe 3.0 Card | P01665-B21 |
| HPE CL Eth 2x10Gb X710 PCle3 Card | P01666-B21 |
| HPE CL Ethernet 10Gb 2-port SFP+ QLogic Q41132 PCle 3.0 Card | P01668-B21 |

Additional Options

HPE Storage Controllers

RAID Array Controllers

HPE CL Broadcom 9460-8i 2G with CVPM05 Tri-Mode RAID Controller P01726-B21

NOTE: This option does not support HW RAID with SFF NVME SSD

HPE CL LSI Mega RAID SAS 9361-8i Adapter 859912-B21

NOTE: A supercapacitor/battery clip comes standard with the 8SFF Chassis and the Premium 10SFF chassis to avoid blocking PCIe expansion slots

HBA Controllers

HPE CL LSI MegaRAID SAS 9300-8i Host Bus Adapter Kit

859916-B21

HPE Rack Options

Rail Kits

HPE 1U Gen10 SFF Easy Install Rail Kit 874543-B21

HPE 1U Gen10 SFF Ball Bearing Rail Kit 872252-B21

NOTE: HPE rail kits contain telescoping rails which allow for in-rack serviceability.

NOTE: Hewlett Packard Enterprise recommends that a minimum of two people are required for all Rack Server installations. Please refer to your installation instructions for proper tools and number of people to use for any installation.

HPE 1U Cable Management Arm for Rail Kit 734811-B21

NOTE: Supports both the Easy Install and Ball Bearing Rail Kits.

HPE Racks

NOTE: Please see the **HPE Advanced Series Racks QuickSpecs** for information on additional racks options and rack specifications.

NOTE: Please see the <u>HPE Enterprise Series Racks QuickSpecs</u> for information on additional racks options and rack specifications.

NOTE: Please see the **HPE Standard Series Racks QuickSpecs** for information on additional racks options and rack specifications.

HPE Power Distribution Units (PDUs)

NOTE: Please see the **HPE Basic Power Distribution Units (PDU) QuickSpecs** for information on these products and their specifications.

NOTE: Please see the **HPE Metered Power Distribution Units (PDU) QuickSpecs** for information on these products and their specifications.

NOTE: Please see the **HPE Intelligent Power Distribution Unit (PDU) QuickSpecs** for information on these products and their specifications.

NOTE: Please see the **HPE Metered and Switched Power Distribution Units (PDU) QuickSpecs** for information on these products and their specifications.

HPE Uninterruptible Power Systems (UPS)

NOTE: To learn more, please visit the HPE Uninterruptible Power Systems (UPS) web page.

NOTE: Please see the **HPE DirectFlow Three Phase Uninterruptible Power System QuickSpecs** for information on these products and their specifications.

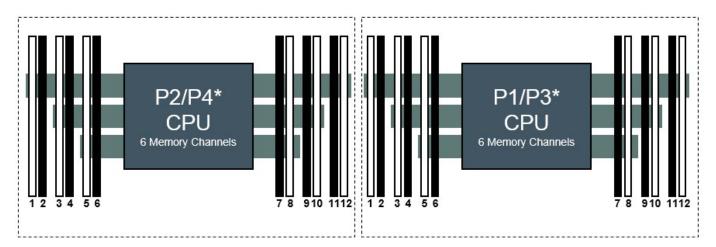
NOTE: Please see the **HPE Line Interactive Single Phase UPS QuickSpecs** for information on these products and their specifications.

Additional Options

| HPE Cloudline Support Services | |
|--|--------|
| HPE 3 year Cloudline Parts plus Remote Technical with DMR CL2600 Gen10 Supp | HF8N4E |
| HPE 3 year Cloudline Parts plus Remote Technical with CDMR CL2600 Gen10 Supp | HF8N5E |
| HPE Foundation Care 3 Years Next Business Day Services | |
| HPE 3 Year Foundation Care Next Business Day Cloudline 2600 Gen10 Service | HF8N6E |
| HPE 3 Year Foundation Care Next Business Day with DMR Cloudline 2600 Gen10 Service | HF8N7E |
| HPE 3 Year Foundation Care Next Business Day with CDMR Cloudline 2600 Gen10 Service | HF8N8E |
| HPE Foundation Care 4 Years Next Business Day Services | |
| HPE 4 Year Foundation Care Next Business Day Cloudline 2600 Gen10 Service | HF8N9E |
| HPE 4 Year Foundation Care Next Business Day with DMR Cloudline 2600 Gen10 Service | HF8P0E |
| HPE 4 Year Foundation Care Next Business Day with CDMR Cloudline 2600 Gen10 Service | HF8P1E |
| HPE Foundation Care 5 Years Next Business Day Services | |
| HPE 5 Year Foundation Care Next Business Day Cloudline 2600 Gen10 Service | HF8P2E |
| HPE 5 Year Foundation Care Next Business Day with DMR Cloudline 2600 Gen10 Service | HF8P3E |
| HPE 5 Year Foundation Care Next Business Day with CDMR Cloudline 2600 Gen10 Service | HF8P4E |
| NOTE: For a full listing of support services available for this server, please visit https://ssc.hpe.com/ | |
| | |

Memory

Memory Population guidelines



2 Slots per Channel

| 1 DIMM | | | | | | | | 8 | | | | |
|----------|---|---|---|---|---|---|---|---|---|----|----|----|
| 2 DIMMs | | | | | | | | 8 | | 10 | | |
| 3 DIMMs | | | | | | | | 8 | | 10 | | 12 |
| 4 DIMMs | | | 3 | | 5 | | | 8 | | 10 | | |
| 5 DIMMs | | | 3 | | 5 | | | 8 | | 10 | | 12 |
| 6 DIMMs | 1 | | 3 | | 5 | | | 8 | | 10 | | 12 |
| 7 DIMMs | 1 | | 3 | | 5 | | 7 | 8 | | 10 | | 12 |
| 8 DIMMs | | | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 10 | | |
| 9 DIMMs | 1 | | 3 | | 5 | | 7 | 8 | 9 | 10 | 11 | 12 |
| 10 DIMMs | 1 | | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 10 | | 12 |
| 11 DIMMs | 1 | | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 10 | 11 | 12 |
| 12 DIMMs | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 10 | 11 | 12 |

DIMM Population Order

General Memory Population Rules and Guidelines:

- Install DIMMs only if the corresponding processor is installed.
- If only one processor is installed in a two-processor system, only half of the DIMM slots are available.
- To maximize performance, it is recommended to balance the total memory capacity between all installed processors.
- When two processors are installed, balance the DIMMs across the two processors.
- White DIMM slots denote the first slot to be populated in a channel.
- Mixing of DIMM types (RDIMM, and LRDIMM) is not supported.
- The maximum memory speed is a function of the memory type, memory configuration, and processor model.
- The maximum memory capacity is a function of the number of DIMM slots on the platform, the largest DIMM capacity qualified on the platform, the number and model of installed processors qualified on the platform.

Memory

| DIMM Type | Register DIMM (RDIMM) | | | | | |
|------------------------------|---|----------------------------------|-----------------------------|--|--|--|
| HPE SKU P/N | 881067-B21 | P07029-B21 | 880841-B21 | | | |
| | HPE CL 16GB (1x16GB) Single | HPE CL 16GB (1x16GB) Dual | HPE CL 32GB (1x32GB) Dual | | | |
| | Rank x8 DDR4-2666 CAS-19- | Rank x8 DDR4-2666 CAS-19- | Rank x4 DDR4-2666 CAS-19- | | | |
| | 19-19 Registered Memory FIO | 19-19 Registered Memory FIO | 19-19 Registered Memory FIO | | | |
| SKU Description | Kit | Kit | Kit | | | |
| DIMM Rank | Single Rank (1R) | Dual Rank (2R) | Dual Rank (2R) | | | |
| DIMM Capacity | 16GB | 16GB | 32GB | | | |
| Voltage | 1.2V | 1.2V | 1.2V | | | |
| DRAM depth [bit] | 2G | 1G | 2G | | | |
| DRAM Width [bit] | ×4 | x8 | ×4 | | | |
| DRAM Density | 8Gb | 8Gb | 8Gb | | | |
| CAS Latency | 19-19-19 | 19-19-19 | 19-19-19 | | | |
| DIMM Native Speed (MT/s) | 2666 MT/s | 2666 MT/s | 2666 MT/s | | | |
| Intel Xeon®Platinum/Gold | 81xx/61xx Processors Officially | Supported Memory Speed (MT/s | s) | | | |
| 1 DIMM Per Channel | IMM Per Channel 2666 MT/s 2666 MT/s 2666 MT/s | | 2666 MT/s | | | |
| 2 DIMM Per Channel 2666 MT/s | | 2666 MT/s | 2666 MT/s | | | |
| Intel Xeon®Gold/Silver 51 | xx/41xx Processors Officially Sup | pported Memory Speed (MT/s) | | | | |
| 1 DIMM Per Channel | 2400 MT/s | 2400 MT/s | 2400 MT/s | | | |
| 2 DIMM Per Channel | 2400 MT/s | 2400 MT/s | 2400 MT/s | | | |
| Intel Xeon®Bronze 31xx P | rocessors Officially Supported Me | emory Speed (MT/s) | | | | |
| 1 DIMM Per Channel | 2133 MT/s | 2133 MT/s | 2133 MT/s | | | |
| 2 DIMM Per Channel | 2 DIMM Per Channel 2133 MT/s 2133 MT/s 2133 MT/s | | | | | |
| NOTE: The maximum men | nory speed is a function of the men | nory type, memory configuration, | and processor model. | | | |
| For details on the HPE Serv | er Memory speed, visit: https://ww | w.hpe.com/docs/memory-speed | <u>-table</u> | | | |

Memory

| DIMM Туре | Load Reduced (LRDIMM) |
|---|---|
| HPE CL 64GB (1x64GB) Quad Rank x4 DDR4-2666 CAS-19-19-19 Load Reduced Memory FIO Kit | 880842-B21 |
| SKU Description | HPE CL 64GB (1x64GB) Quad Rank x4 DDR4-2666 CAS-19-19 Load Reduced Memory FIO Kit |
| DIMM Rank | Quad Rank (4R) |
| DIMM Capacity | 64GB |
| Voltage | 1.2V |
| DRAM depth [bit] | 2G |
| DRAM Width [bit] | x4 |
| DRAM Density | 8Gb |
| CAS Latency | 19-19-19 |
| DIMM Native Speed (MT/s) | 2666 MT/s |
| Intel Xeon® Platinum/Gold | 81xx/61xx Processors Officially Supported Memory Speed (MT/s) |
| 1 DIMM Per Channel | 2666 MT/s |
| 2 DIMM Per Channel | 2666 MT/s |
| Intel Xeon® Gold/Silver 51x | xx/41xx Processors Officially Supported Memory Speed (MT/s) |
| 1 DIMM Per Channel | 2400 MT/s |
| 2 DIMM Per Channel | 2400 MT/s |
| Intel Xeon® Bronze 31xx Pr | ocessors Officially Supported Memory Speed (MT/s) |
| 1 DIMM Per Channel | 2133 MT/s |
| 2 DIMM Per Channel | 2133 MT/s |
| NOTE: The maximum memo | ry speed is a function of the memory type, memory configuration, and processor model. |

DDR4 memory options part number decoder

NOTE: Capacity references are rounded to the common gigabyte (GB) values.

16GB = 16,384 MB

32GB = 32,768 MB

64GB = 65,536 MB

Storage



8SFF Chassis Drive Bay Numbering



8 SFF Chassis + optional 2 NVMe Drive Bay Numbering

NOTE: Bays 0 and 1 (highlighted) ONLY support NVMe Drives. The other bays support a mix of SATA and SAS drives.



Premium 10 SFF Chassis Drive Bay Numbering

NOTE: Bays 8 and 9 ONLY support NVMe Drives. The other bays support a mix of NVMe, SATA, and SAS drives.

Technical Specifications

| System L | Jnit |
|----------|------|
|----------|------|

Dimensions 4.29 x 43.46 x 70.7 cm SFF Drives

(Height x Width x Depth) 1.69 x 17.11 x 27.83 in

Weight (approximate) 13.04 kg

28.74 lb

SFF minimum: One drive, one processor, one power supply, two heatsinks,

one storage controller, and five fans.

16.27 kg 35.86 lb

SFF maximum: 10 drives, two processors, two power supplies, two heatsinks,

one storage controller and seven fans.

Input Requirements

(per power supply)

Rated Line Voltage

100 to 120 VAC 200 to 240 VAC

Maximum For 800W Power Supply: 3207 BTU/hr (at 100 VAC), 3071 BTU/hr (at 200 **BTU Rating**

VAC), 3112 BTU/hr (at 240 VDC) for China Only

For 500W Power Supply: 1979 BTU/hr (at 100 VAC), 1911 BTU/hr (at 200

VAC), 1965 BTU/hr (at 240 VDC) for China Only

Power Supply Output

(per power supply)

Rated Steady-State

Power

For 1600W Power Supply: 1600W (at 240 VAC), 1600W (at 240 VDC) for

China only

For 800W Power Supply: 800W (at 100 VAC), 800W (at 240 VAC), 800W

(at 240 VDC) input for China only

For 500W Power Supply: 500W (at 100 VAC), 500W (at 240 VAC), 500W

(at 240 VDC) input for China only

Maximum Peak Power

For 1600W Power Supply: 1600W (at 200 to 240 1VAC), 1600W (at 240

VDC) input for China only

System Inlet Temperature Standard Operating

Support

10° to 35°C (50° to 95°F) at sea level with an altitude derating of 1.0°C per every 305 m (1.8°F per every 1000 ft) above sea level to a maximum of 3050 m (10,000 ft), no direct sustained sunlight. Maximum rate of change is 20°C/hr (36°F/hr). The upper limit and rate of change may be limited by the type and number of options installed.

System performance during standard operating support may be reduced if

operating with a fan fault or above 30°C (86°F).

For approved hardware configurations, the supported system inlet range is extended to be: 5° to 10°C (41° to 50°F) and 35° to 40°C (95° to 104°F) at sea level with an altitude derating of 1.0°C per every 175 m (1.8°F per every 574 ft) above 900 m (2953 ft) to a maximum of 3050 m (10,000 ft). The approved hardware configurations for this system are listed at the URL:

http://www.hpe.com/servers/ashrae

Extended Ambient Operating Support For approved hardware configurations, the supported system inlet range is extended to be: 40° to 45°C (104° to 113°F) at sea level with an altitude derating of 1.0°C per every 125 m (1.8°F per every 410 ft) above 900 m (2953 ft) to a maximum of 3050 m (10,000 ft). The approved hardware configurations for this system are listed at the URL:

http://www.hpe.com/servers/ashrae

System performance may be reduced if operating in the extended ambient operating range or with a fan fault.

Technical Specifications

| Relative Humidity (non-condensing) | Operating | 8% to 90% - Relative humidity (Rh), 28°C maximum wet bulb temperature, non-condensing. | | | |
|---|-----------------|--|--|--|--|
| | Non-operating | 5 to 95% relative humidity (Rh), 38.7°C (101.7°F) maximum wet bulb temperature, non-condensing. | | | |
| Altitude | Operating | 3050 m (10,000 ft). This value may be limited by the type and number of options installed. Maximum allowable altitude change rate is 457 m/min (1500 ft/min). | | | |
| | Non-operating | $9144\mathrm{m}$ (30,000 ft). Maximum allowable altitude change rate is $457\mathrm{m/min}$ (1500 ft/min). | | | |
| A | 1 :-4 d d d d d | A 10/15 to the total or the control of 10/10/10 and the control of | | | |

Acoustic Noise

Listed are the declared A-Weighted sound power levels (LWAd) and declared average bystander position A-Weighted sound pressure levels (LpAm) when the product is operating in a 23°C ambient environment. Noise emissions were measured in accordance with ISO 7779 (ECMA 74) and declared in accordance with ISO 9296 (ECMA 109). The listed sound levels apply to standard shipping configurations. Additional options may result in increased sound levels. Please have your HPE representative provide information from the HPE EMESC website for further technical details regarding the configurations listed below.

| Example Configuration | 8SFF Entry-Level Configuration | Premium 10SFF Performance Configuration | |
|-----------------------|-----------------------------------|--|--|
| Idle | | | |
| LWAd | 5.1 B | 5.2 B | |
| LpAm | 35 dBA | 36 dBA | |
| Operating | | | |
| LWAd | 5.3 B | 5.9 B | |
| LpAm | 36 dBA | 45 dBA | |

NOTE: Acoustics levels presented here are generated by a test configuration only. Acoustics levels will vary depending on system configuration. Values are subject to change without notification and are for reference only.

Emissions Classification (EMC)

To view the regulatory information for your product, view the Safety and Compliance Information for Server, Storage, Power, Networking, and Rack Products, available at the Hewlett Packard Enterprise Support Center:

http://www.hpe.com/support/Safety-Compliance-EnterpriseProducts

Environment-friendly Products and Approach - End-of-life Management and Recycling

Hewlett Packard Enterprise offers **end-of-life product return, trade-in, and recycling programs**, in many geographic areas, for our products. Products returned to Hewlett Packard Enterprise will be recycled, recovered or disposed of in a responsible manner.

The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the **Hewlett Packard Enterprise web site**. These instructions may be used by recyclers and other WEEE treatment facilities as well as Hewlett Packard Enterprise OEM customers who integrate and re-sell Hewlett Packard Enterprise equipment.

Summary of Changes

| Date | Version History | Action | Description of Change |
|-------------|-----------------|---------|---|
| 02-Apr-2019 | Version 4 | Changed | Addition of network card and removed OBS SKUs |
| 04-Mar-2019 | Version 3 | Changed | Obsolete SKUs were removed |
| 04-Feb-2019 | Version 2 | J | Addition of NVMe-related content. Overview, Standard Features, Configuration Information, Core Options, Storage and Technical Specification sections were updated |
| 03-Dec-2018 | Version 1 | New | New QuickSpecs. |







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For hard drives, 1GB = 1 billion bytes. Actual formatted capacity is less

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